

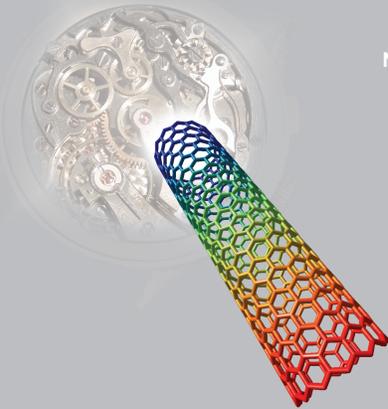
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C. S. Chen
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The scope of the journal is covered by the topics: computer modeling & simulation; analysis and synthesis of engineered structural and functional materials; biomaterials; smart materials and structures; solid and fluid mechanics; micro-electromechanical systems; nano-electromechanical systems; nano-micro-macro-level coupled modeling; nano-structured composites; chemomechanical engineering in biosystems; and application of these sciences and technologies in process-and-product development for economic growth, etc.



About the Editors:

Z-Z. Cen is a Vice President, and Professor of Engineering Mechanics, at Tsinghua University, one of the most prestigious universities in China and in the world. Prof. C. S. Chen, a well-known mathematician, is based in the University of Nevada at Las Vegas, in the USA. G. Prathap is a renowned Scientist at the National Aerospace Laboratory in Bangalore, India, which is home to a world-class group of researchers. N. Ramakrishnan is the Director of the Regional Research Laboratory in Bhopal, India; and is an eminent materials Scientist.

The Honorary Editor, Satya N. Atluri, Editor-in-Chief of the companion Journal, "CMES: Computer Modeling in Engineering & Sciences", is a Fellow of several academies: the American Academy of Mechanics, European Academy of Sciences, the Third World Academy of Sciences, the Indian National Academy of Engineering, and the U. S. National Academy of Engineering.

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The countries represented by the international editorial board [which will be continually updated] are homes to an increasingly vast number of highly distinguished researchers in the disciplines covered by CMC. The aim of CMC is to become a depository for the research in the burgeoning fields of computer modeling, advanced engineered and bio-materials, and continua, from the best minds from these countries and from around the world.

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